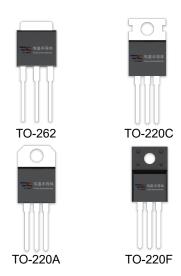


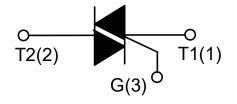
DESCRIPTION:

The BTB12-800C SCR series with the parallel resistor between Gate and Cathode are especially recommended for use on straight hair, igniter, anion generator, etc.



MAIN FEATURES

Symbol	Symbol Value	
I _{T(RMS)}	12	А
V _{DRM} /V _{RRM}	600/800/1200	V



ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Storage junction temperature range		T _{stg}	-40-150	$^{\circ}\!\mathbb{C}$
Operating junction	erating junction temperature range		-40-125	$^{\circ}$ C
Repetitive peak off	-state voltage (T _j =25℃)	V _{DRM}	600/800/1200	V
Repetitive peak rev	verse voltage (Tj=25℃)	V _{RRM}	600/800/1200	V
Non repetitive surge peak Off-state voltage		V _{DSM} V _{DRM} +100		V
Non repetitive pea	k reverse voltage	VRSM	V _{RRM} +100	V
	TO-220A(Ins) (Tc=85°C)			
RMS on-state current	TO-262/ TO-220A(Non-Ins)/ TO-220C(Tc=100°C) TO-220F(Ins) (Tc=80°C)	I _{T(RMS)}	12	А



Non repetitive surge peak on-state current (full cycle, F=50Hz)		I _{TSM}	120	А
I ² t value for fusing (tp=10ms)		l²t	78	A ² s
Critical rate of rise of on-state current ($I_G = 2 \times I_{GT}$)		dl/dt	50	A/µs
Peak gate current		I _{GM}	4	Α
Average gate power dissipation		P _{G(AV)}	1	W
Peak gate power		P _{GM}	5	W

3 Quadrants

Symbol	Test Condition Quadran	Quadrant		Value			Unit	
		Quadrant		BW	CW	sw	TW	Offic
Ідт	\/ ₀ =12\/ B₁ =22O	I - II -III	MAX	50	35	10	5	mA
V _{GT}	V _D =12V R _L =33Ω	I - II -III	MAX		1.3	3		V
V _{GD}	$V_D = V_{DRM} T_j = 125^{\circ}C$ $R_L = 3.3 K\Omega$	I - II -III	MIN	0.2		V		
I _L I _G =1.2	I _G = 1.2I _{GT} I - III	I -III	MAX	80	50	30	20	mΛ
		IVIAA	90	60	40	30	mA	
Ін	I _T =100mA		MAX	60	40	20	15	mA
dV/dt	V _D =2/3V _{DRM} Gate Open T _j =125℃		MIN	1000	500	200	100	V/µs
(dl/dt)c	Without snubber T _j =125℃		MIN	12	6.5	-	-	A/ms

4 Quadrants

Symbol	Test Condition	Quadrant		Value		Unit	
				В	С	Oilit	
lo-		I - II -III	MAX	50	25	mA	
lgт	V _D =12V R _L =33Ω	IV		70	50		
V _G T		ALL	MAX	1	.3	V	
V _{GD}	$V_D = V_{DRM} T_j = 125^{\circ}C$ $R_L = 3.3 K\Omega$	ALL	MIN	0.2		V	
IL	I _G =1.2I _{GT}	I_L $I_G = 1.2I_{GT}$ $I_G = 1.2I_{GT}$ II II	I -III-IV	MAY	50	40	mΛ
			IVIAA	100	80	mA	



lн	I _T =100mA	MAX	50	25	mA
dV/dt	V _D =2/3V _{DRM} Gate Open T _j =125℃	MIN	500	200	V/µs
(dV/dt)c	(dI/dt)c=5.3A/ms T _j =125℃	MIN	10	5	V/µs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V _{TM}	I _{тм} =17A tp=380µs	T _j =25℃	1.5	V
IDRM		T _j =25℃	5	μΑ
I _{RRM}	$V_D = V_{DRM} V_R = V_{RRM}$	T _j =125℃	1	mA

THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
		TO-220A(Ins)	2.3	
R _{th(j-c)}	junction to case(AC)	TO-262/ TO-220A(Non-Ins)/ TO-220C	1.4	°C/W
		TO-220F(Ins)	2.5	



FIG.1 Maximum power dissipation versus RMS on-state current

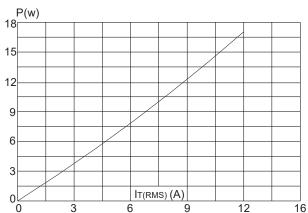


FIG.3: Surge peak on-state current versus number of cycles

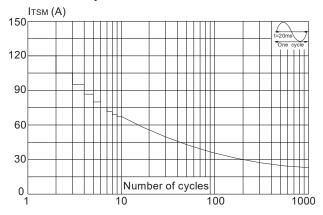


FIG.2: RMS on-state current versus case temperature

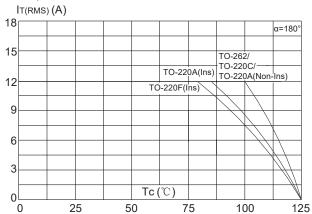


FIG.4: On-state characteristics (maximum values)

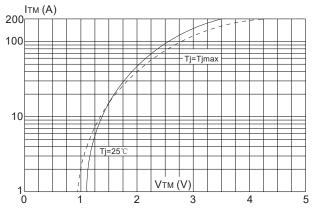




FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<20ms, and corresponging value of I²t (dI/dt(I-I-II) < 50A/µs)

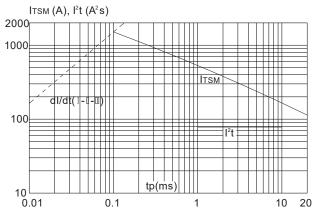


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature

